ASSOCIATION CONNECT: ELECTRONICS INDUSTR	© Copyright 2005, IPC.	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.				This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.										
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Typ http://www.ipc.org/IPC-175x Distribute				Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater						als and Mf	g Inforr	mation		
Supplier Inform	mation															
Company name*				Company unique ID			Unique ID Authority					Response Date*				
nsemi											2023-06-06					
Contact Name		Title - Contact			I	Phone - Contact*					Email - Contact*					
Product-Env-Stew	vards	Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com						
Authorized Representative* Title				Title - Representative			Phone - Representative*				Email - Representative*					
Product-Env-Stewards			Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com					
Reques	ester Item Number Mfr Item		em Number Mfr Item Name				Effective Dat	te Versio	Version Mar		Manufacturing Site		/eight*		UOM	Unit Type
		PCA9617ADMR2G Level-Tr		Level-Translating	evel-Translating Fm+ I2C-Bus Repeater		2023-06-06	2023-06-06 THB			24.310438		38	mg	Each	
Ianufacturing	g Proccess Information	ı														
Termina	Plating / Grid Array Material		Terminal Base Alloy J		J-STD-020 MSL	STD-020 MSL Rating		Peak Process Body Temperatur		re Max Time at Peak Temper		Temperatu	ure Number of Reflow Cycles		les	
Precious metal (e.g. Ag,Au, NiPdAu) (no Sn)		1) (no C	CU Alloy 1		1		260		С		30 seco		ls 3			
Comments																
vel 1 - maximum	time at peak temperature d	luring sol	dering is 10-3	0 seconds												
For more informat	tion regarding material com	position]	please refer to	page 3				<u> </u>								

RoHS Material Composition Declaration			Declaration Type *	Detail	ed							
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).												
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on informationprovided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier has not orditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusivesource of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty ri												
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted							
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.												
Exemption List Version	EL-2011/534/EU											
Declaration Signature												
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the							

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.34	mg	Supplier	Silicon (Si)	7440-21-3		0.34	mg
Die Attach	0.13	mg	Supplier	Ethylene glycol dicyclopentenyl ether methacrylate	68586-19-6		0.0045	mg
			Supplier	Bis(a,a-dimethylbenzyl) Peroxide	80-43-3		0.0008	mg
			Supplier	Silver (Ag)	7440-22-4		0.1246	mg
Lead Frame	11.2259	mg	Supplier	Zinc (Zn)	7440-66-6		0.0135	mg
			Supplier	Iron (Fe)	7439-89-6		0.2638	mg
			Supplier	Copper (Cu)	7440-50-8		10.9453	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0034	mg
Mold Compound-Black	12.4	mg		Epoxy resin	proprietary data		0.62	mg
			Supplier	Phenolic Resin	Proprietary Data		0.62	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		0.248	mg
			Supplier	Carbon Black (C)	1333-86-4		0.062	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		10.85	mg
Plating	0.114539	mg	Supplier	Palladium (Pd)	7440-05-3		0.0229	mg
			В	Nickel (Ni)	7440-02-0		0.0905	mg
			Supplier	Gold (Au)	7440-57-5		0.0011	mg
Wire Bond - Au	0.1	mg	Supplier	Gold (Au)	7440-57-5		0.1	mg